



DISCRIPTION

FEATURES

Ceramic Core High Frequency Desgin Lower DCR permits High Idc Available in E 12 serie Excellent Q SRF Values Excellent Thermal Stability Lead Free versions

OPTIONS

Tape & Reel is Standard (Qty: 2000 Pcs) Bulk Packing Available for smaller quantites Tolerance: K = 10% and M=20% is Standard, tighter Tolerance available (MOQ on request)

APPLICATIONS

Modems PDP, LCD TVs convertor Mobile Radios DC/DC convertor Cordless Telephones Car radios Global Positioning Systems Wireless Communications Equipment Network Systems Computer Peripheral Equipment

PHYSICAL CHARACTERISTICS

- Testing : (Equivalents acceptable) Inductance : HP4291A, HP16193A, HPA4286A or equivalent RDC : QuadTech 1880 m Ω Q : HP4342A SRF : HP4191A
- Rated Current L value drop 10% typ at IDC against its initial value
- Temperature rise 40°C Max Reference ambient temperature
- Solderability : 75% of the terminal electrode shall be convered
- Soldering Methods : Wave, Reflow
- Operating Temperature : -25°C ~ +85°C
- Storage Temperature : -55°C ~ +125°C

ELECTRICAL SPECIFICATIONS

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	1,0	μH	see Site 2
Q factor		Q	10		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	0,117	Ω	max.
Self-Res. Freq.		SRF	96	Mhz	min.
Test-Freq.			1 / 1	KHz / Mhz	
Rated Current		IDC	800	mA	max.
Saturation Current		Isat		mA	typ.

 This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon –Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability functions. 						HIGH CURRENT SMT CERAMIC WIRE-WOUND CHIP INDUCTORS		
						Part No.: \$15007-1R0		
						Customer:		
DRW:	Chang	CHKD	Young	MATL:	Chu Chi	DATE	10.06.2009	
APPD:	Pona			FINISH	Vienna	Sheet	1 from 2	

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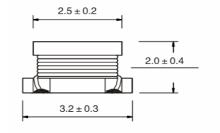
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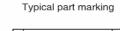


TECHNICAL INFORMATIONS

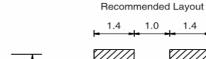
Dimensions (mm)



0.9









1.4

Ordering Information

Telerence

 2.5 ± 0.2

Serie and Range

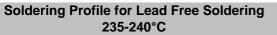
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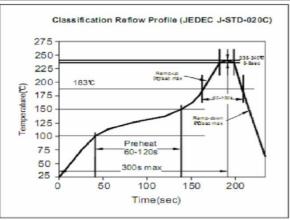
1.3

S15007-1R0

loierance	ROH5	Packing		
	-			
K	R	TR		
K = 10%	R = ROHS	BU = Bulk Ware		
M = 20%	N = non ROHS	TR = Tape Reel		

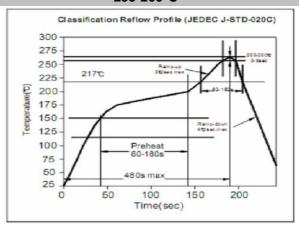
POLIC





Soldering Profile for Lead Free Soldering 255-260°C

Deeking



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